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J.R.

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Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : KUEI-WU HUANG ET AL  
Serial No. : 09/517,987  
Filed : March 3, 2000  
For : METHOD OF FORMING PLANARIZED STRUCTURES  
IN AN INTEGRATED CIRCUIT  
Group No. : 2812  
Examiner : R.A. Booth

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TECHNOLOGY CENTER 2800

**BOX AF**  
Commissioner for Patents  
Washington, D. C. 20231

Sir:

**NOTICE OF APPEAL**

Applicant hereby appeals to the Board of Appeals from the decision dated May 17, 2002 of the Primary Examiner finally rejecting Claims 77-96.

A check in the amount of \$320.00 is enclosed in payment of the Notice of Appeal filing fee.

The Commissioner is hereby authorized to charge any additional fees connected with this communication or credit any overpayment to Davis Munck Deposit Account No. 50-0208.

07/23/2002 AWONDAF1 00000061 09517987

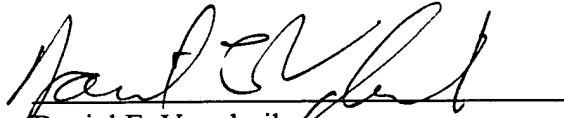
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320.00 DP

Respectfully submitted,

DAVIS MUNCK, P.C.

Date: 7-17-02

  
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